MEMORY CHIPS

Memory chips are usually organized in the form of an array of cells, in which each cell is capable of storing one bit of information. A row of cells constitutes a memory word, and the cells of a row are connected to a common line referred to as the word line, and this line is driven by the address decoder on the chip. The cells in each column are connected to a sense/write circuit by two lines known as bit lines. The sense/write circuits are connected to the data input/output lines of the chip. During a READ operation, the Sense/Write circuits sense, or read, the information stored in the cells selected by a word line and transmit this information to the output lines. During a write operation, they receive input information and store it in the cells of the selected word.

The following figure shows such an organization of a memory chip consisting of 16 words of 8 bits each, which is usually referred to as a 16 x 8 organization.

The data input and the data output of each Sense/Write circuit are connected to a single bi-directional data line in order to reduce the number of pins required. One control line, the R/W (Read/Write) input is used to specify the required operation and another control line, the CS (Chip Select) input is used to select a given chip in a multichip memory system. This circuit requires 14 external connections, and allowing 2 pins for power supply and ground connections, can be manufactured in the form of a 16-pin chip. It can store $16 \times 8 = 128$ bits.

Another type of organization for 1k x 1 format is shown below:
The 10-bit address is divided into two groups of 5 bits each to form the row and column addresses for the cell array. A row address selects a row of 32 cells, all of which are accessed in parallel. One of these, selected by the column address, is connected to the external data lines by the input and output multiplexers. This structure can store 1024 bits, can be implemented in a 16-pin chip.

A Typical Memory Cell

Semiconductor memories may be divided into bipolar and MOS types. They may be compared as follows:

<table>
<thead>
<tr>
<th>Characteristic</th>
<th>Bipolar</th>
<th>MOS</th>
</tr>
</thead>
<tbody>
<tr>
<td>Power Dissipation</td>
<td>More</td>
<td>Less</td>
</tr>
<tr>
<td>Bit Density</td>
<td>Less</td>
<td>More</td>
</tr>
<tr>
<td>Impedance</td>
<td>Lower</td>
<td>Higher</td>
</tr>
</tbody>
</table>
Bipolar Memory Cell

A typical bipolar storage cell is shown below:

Two transistor inverters connected to implement a basic flip-flop. The cell is connected to one word line and two bits lines as shown. Normally, the bit lines are kept at about 1.6V, and the word line is kept at a slightly higher voltage of about 2.5V. Under these conditions, the two diodes D1 and D2 are reverse biased. Thus, because no current flows through the diodes, the cell is isolated from the bit lines.

Read Operation:-

Let us assume the Q1 on and Q2 off represents a 1 to read the contents of a given cell, the voltage on the corresponding word line is reduced from 2.5 V to approximately 0.3 V. This causes one of the diodes D1 or D2 to become forward-biased, depending on whether the transistor Q1 or Q2 is conducting. As a result, current flows from bit line b when the cell is in the 1 state and from bit line b when the cell is in the 0 state. The Sense/Write circuit at the end of each pair of bit lines monitors the current on lines b and b’ and sets the output bit line accordingly.

Write Operation: -

While a given row of bits is selected, that is, while the voltage on the corresponding word line is 0.3V, the cells can be individually forced to either the 1 state
by applying a positive voltage of about 3V to line b’ or to the 0 state by driving line b.
This function is performed by the Sense/Write circuit.

**MOS Memory Cell:**

MOS technology is used extensively in Main Memory Units. As in the case of bipolar memories, many MOS cell configurations are possible. The simplest of these is a flip-flop circuit. Two transistors T1 and T2 are connected to implement a flip-flop. Active pull-up to VCC is provided through T3 and T4. Transistors T5 and T6 act as switches that can be opened or closed under control of the word line. For a read operation, when the cell is selected, T5 or T6 is closed and the corresponding flow of current through b or b’ is sensed by the sense/write circuits to set the output bit line accordingly. For a write operation, the bit is selected and a positive voltage is applied on the appropriate bit line, to store a 0 or 1. This configuration is shown below:

![MOS Memory Cell Diagram](image)

**Static Memories Vs Dynamic Memories:**

Bipolar as well as MOS memory cells using a flip-flop like structure to store information can maintain the information as long as current flow to the cell is maintained. Such memories are called static memories. In contracts, Dynamic memories require not only the maintaining of a power supply, but also a periodic “refresh” to maintain the information stored in them. Dynamic memories can have very high bit densities and very lower power consumption relative to static memories and are thus generally used to realize the main memory unit.
Dynamic Memories:-

The basic idea of dynamic memory is that information is stored in the form of a charge on the capacitor. An example of a dynamic memory cell is shown below:

When the transistor T is turned on and an appropriate voltage is applied to the bit line, information is stored in the cell, in the form of a known amount of charge stored on the capacitor. After the transistor is turned off, the capacitor begins to discharge. This is caused by the capacitor's own leakage resistance and the very small amount of current that still flows through the transistor. Hence the data is read correctly only if is read before the charge on the capacitor drops below some threshold value. During a Read operation, the bit line is placed in a high-impedance state, the transistor is turned on and a sense circuit connected to the bit line is used to determine whether the charge on the capacitor is above or below the threshold value. During such a Read, the charge on the capacitor is restored to its original value and thus the cell is refreshed with every read operation.

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